



30V P-Channel Enhancement Mode MOSFET

Voltage

-30 V

Current

-75 A

Features

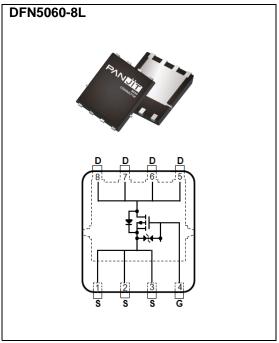
- R_{DS(ON)}, V_{GS}@-10V, I_D@-20A<8.4mΩ
- RDS(ON), VGS@-4.5V, ID@-10A<13.5m Ω
- 100% UIS tested
- Reliable and Rugged
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case : DFN5060-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.08 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETE	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage		V _{DS}	-30	V	
Gate-Source Voltage		V _{GS}	±25	V	
Continuous Drain Current(Note 3)	T _C =25°C		-75		
	T _C =100°C	I _D	-53	А	
Pulsed Drain Current(Note 1)	T _C =25°C	I _{DM}	-215		
Power Dissipation	T _C =25°C	D	75	10/	
	T _C =100°C	Pb —	38	W	
Continuous Drain Current(Note 4)	T _A =25°C		-15.7	Δ.	
	T _A =70°C	I _D	-13.2	A	
Power Dissipation	T _A =25°C	D-	3.3	10/	
	T _A =70°C	PD	2.3	W	
Single Pulse Avalanche Energy(Note 5)		Eas	121	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C	
Thormal Decistor as (Note 4)	Junction to Case	R _{0JC}	2	°C/W	
Thermal Resistance ^(Note 4)	Junction to Ambient	R _{θJA}	45	C/VV	





Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-30	-	-		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA -1		-1.7	-2.5	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-20A	-	6.7	8.4	mΩ	
		V _{GS} =-4.5V, I _D =-10A	-	10.4	13.5		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V	-	-	-1	uA	
Gate-Source Leakage Current		V _{GS} =±25V, V _{DS} =0V	-	-	±10		
	I _{GSS}	V _{GS} =±10V, V _{DS} =0V	-	-	±1	uA	
Dynamic ^(Note 6)	_						
Total Gate Charge	Qg	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	-	54	-	nC	
Gate-Source Charge	Qgs	V _{DS} =-24V, I _D =-20A,	-	6	-		
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V	-	17	-		
Input Capacitance	Ciss)/ 05\/ \/ 0\/	-	2310	-		
Output Capacitance	Coss	V _{DS} =-25V, V _{GS} =0V, f=1MHz	-	332	-	pF	
Reverse Transfer Capacitance	Crss	I=IIVIDZ	-	256	-		
Gate resistance	Rg	f=1MHz	-	2.3	-	Ω	
Turn-On Delay Time	td _(on)	\/ O4\/ O04	-	11	-	ns	
Turn-On Rise Time	tr	V _{DS} =-24V, I _D =-20A,	-	9	-		
Turn-Off Delay Time	td _(off)	$V_{GS}=-10V$, $R_{G}=3\Omega$	-	37	-		
Turn-Off Fall Time	tf	(11010 2)	-	21	-		
Drain-Source Diode							
Diode Forward Current	Is	Tc=25°C	-	-	-75	A	
Pulsed Diode Forward Current	I _{SM}	TC=25 C	-	-	-215		
Diode Forward Voltage	V _{SD}	I _S =-20A, V _{GS} =0V	-	-0.85	-1.3	V	
Reverse Recovery Time	Trr	V _{GS} =0V, I _S =-20A	-	22	-	ns	
Reverse Recovery Charge	Qrr	dl _S /dt=100A/us	-	10	-	nC	

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH, I_{AS} =-22A, V_{DD} =-30V, V_{GS} =-10V, Starting T_{J} =25°C.
- 6. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

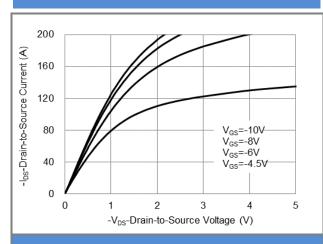


Fig.1 On-Region Characteristics

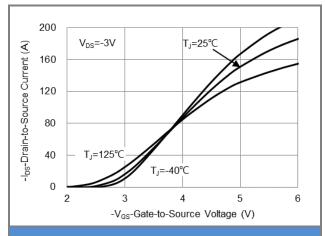


Fig.2 Transfer Characteristics

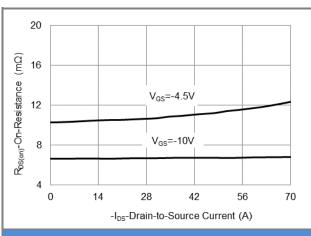


Fig.3 On-Resistance vs. Drain Current

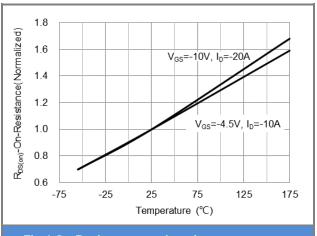


Fig.4 On-Resistance vs. Junction temperature

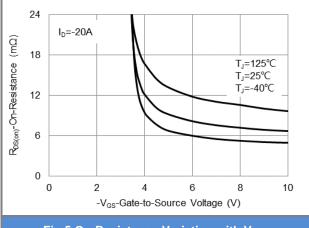


Fig.5 On-Resistance Variation with V_{GS}

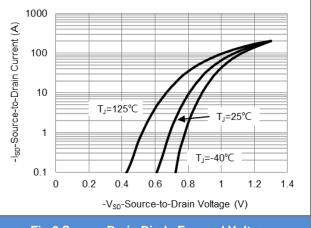


Fig.6 Source-Drain Diode Forward Voltage





TYPICAL CHARACTERISTIC CURVES

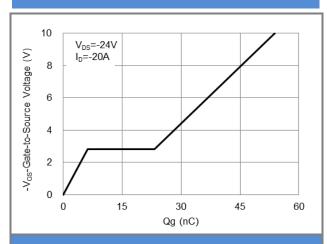


Fig.7 Gate-Charge Characteristics

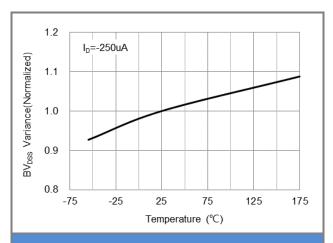


Fig.8 Breakdown Voltage Variation vs. Temperature

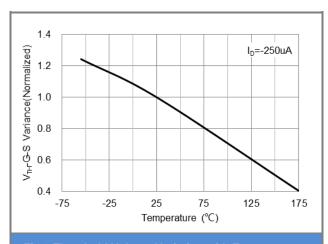


Fig.9 Threshold Voltage Variation with Temperature

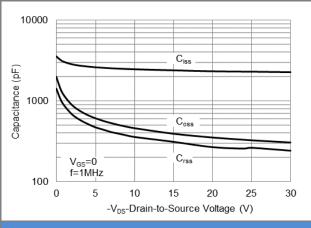
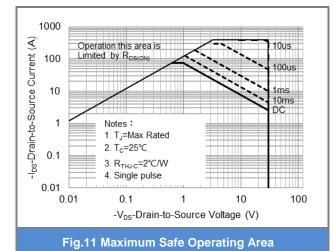


Fig.10 Capacitance vs. Drain-Source Voltage



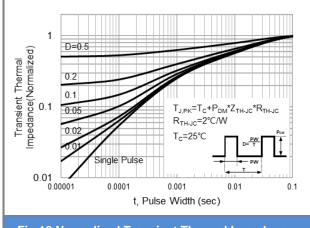


Fig.12 Normalized Transient Thermal Impedance

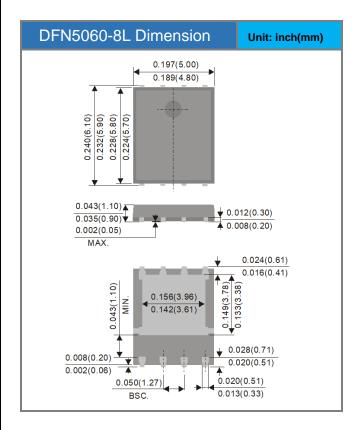


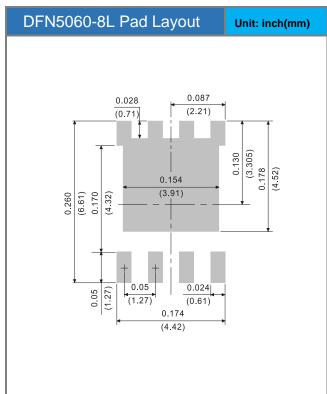


Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJQ5433E-AU	DFN5060-8L	3K pcs / 13" reel	Q5433E	

Packaging Information & Mounting Pad Layout









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